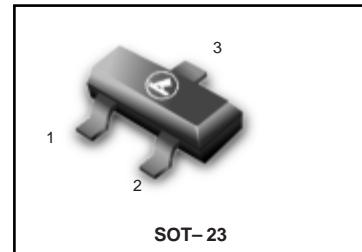


## 60V N-Channel Enhancement-Mode MOSFET

### FEATURES

- $R_{DS(ON)} \leq 100\text{m}\Omega @ V_{GS}=10\text{V}$
- $R_{DS(ON)} \leq 130\text{m}\Omega @ V_{GS}=4.5\text{V}$
- $R_{DS(ON)} \leq 200\text{m}\Omega @ V_{GS}=3.3\text{V}$
- Super high density cell design for extremely low  $R_{DS(ON)}$
- Exceptional on-resistance and maximum DC current capability
- Capable doing Cu wire bonding
- S- Prefix for Automotive and Other Applications Requiring Unique Site and Control Change Requirements; AEC-Q101 Qualified and PPAP Capable.

**LN2308LT1G  
S-LN2308LT1G**

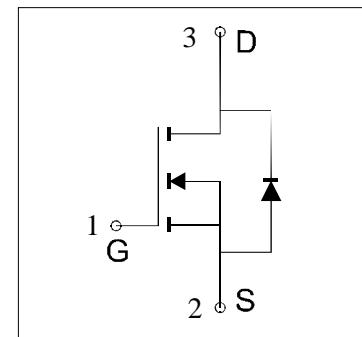


### APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- Load Switch
- DSC

### Ordering Information

Device	Marking	Shipping
LN2308LT1G S-LN2308LT1G	N08	3000/Tape&Reel
LN2308LT3G S-LN2308LT3G	N08	10000/Tape&Reel



### Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ Unless Otherwise Noted)

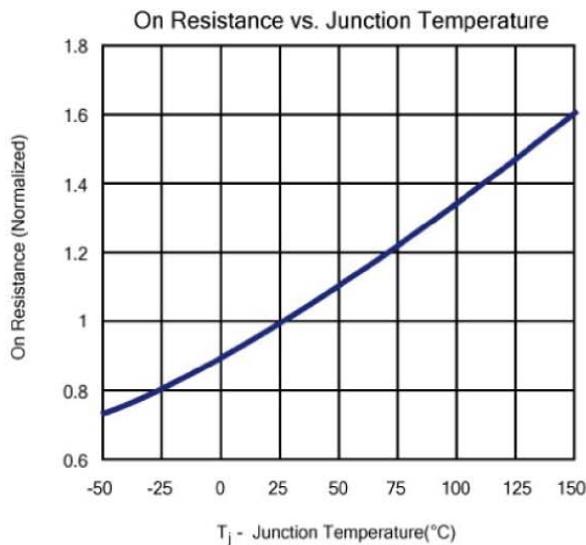
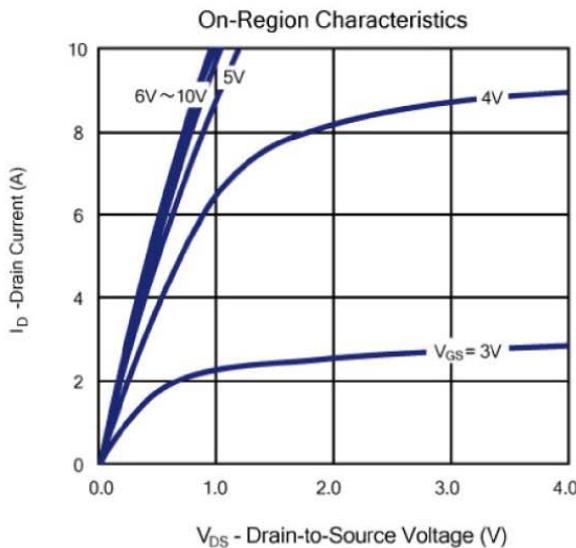
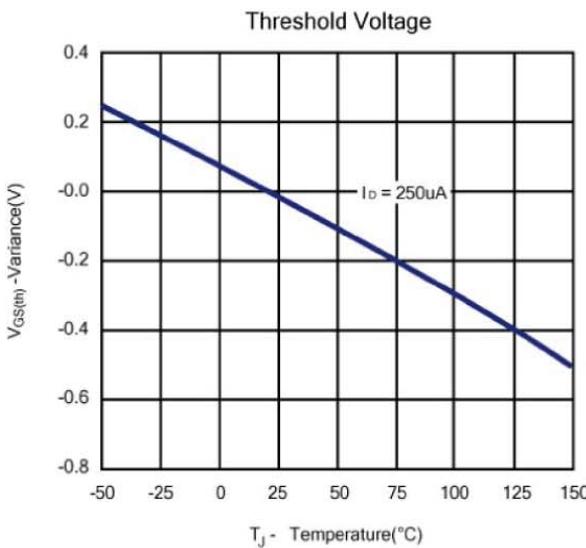
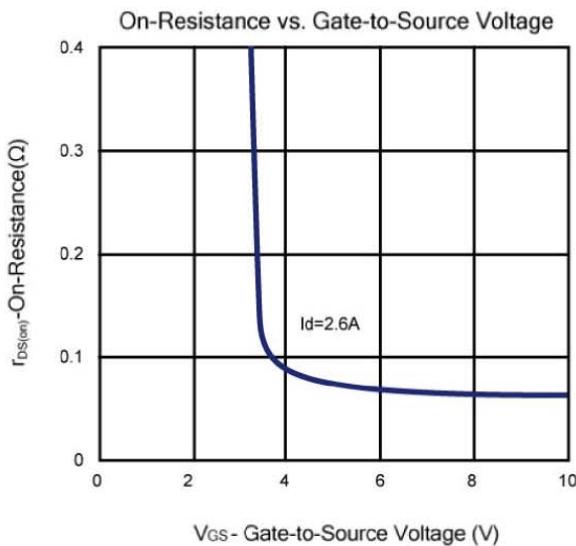
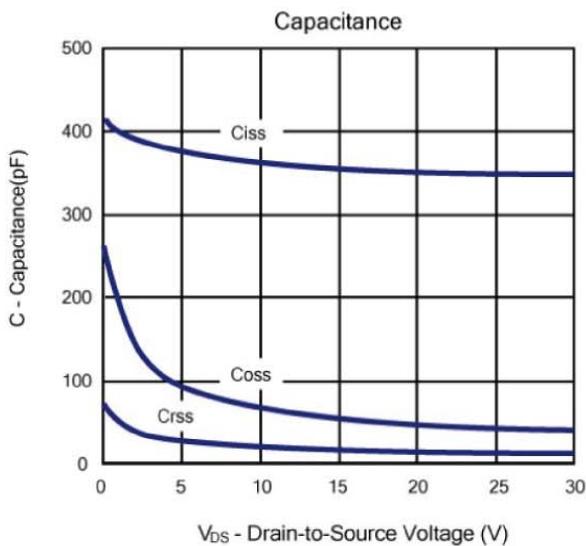
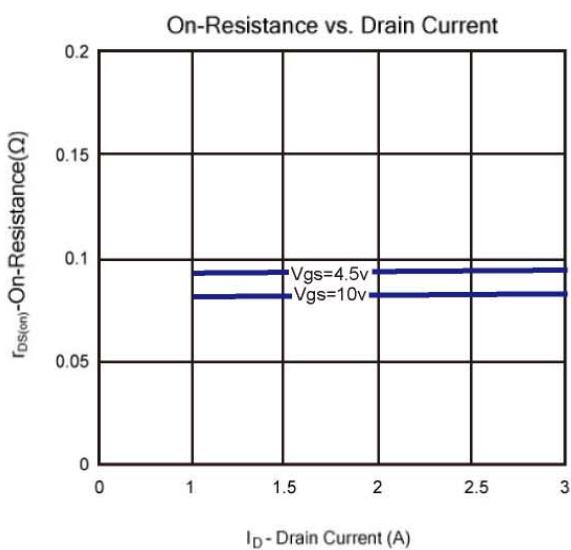
Parameter	Symbol	Limit		Unit
Drain-Source Voltage	$V_{DSS}$	60		V
Gate-Source Voltage	$V_{GSS}$	$\pm 20$		V
Continuous Drain Current ( $T_A=25^\circ\text{C}$ )	$I_D$	2.6		A
Continuous Drain Current ( $T_A=70^\circ\text{C}$ )		1.8		
Pulsed Drain Current	$I_{DM}$	8		
Maximum Body-Diode Continuous Current	$I_S$	1.6		A
Maximum Power Dissipation ( $T_A=25^\circ\text{C}$ )	$P_D$	0.7		W
Maximum Power Dissipation ( $T_A=70^\circ\text{C}$ )		0.45		
Operating Junction Temperature	$T_J$	150		$^\circ\text{C}$
Maximum Junction-to-Ambient	$R_{thJA}$	$T \leq 10 \text{ sec}$	150	$^\circ\text{C}/\text{W}$
Thermal Resistance-Junction to Case		Steady State	175	
Thermal Resistance-Junction to Case	$R_{ejC}$	120		$^\circ\text{C}/\text{W}$

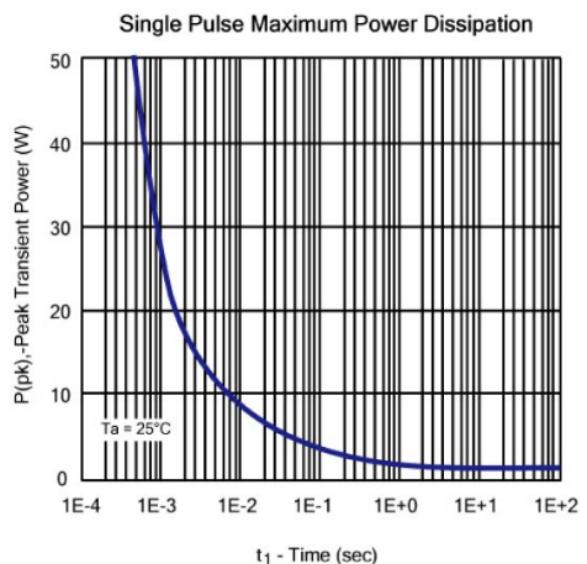
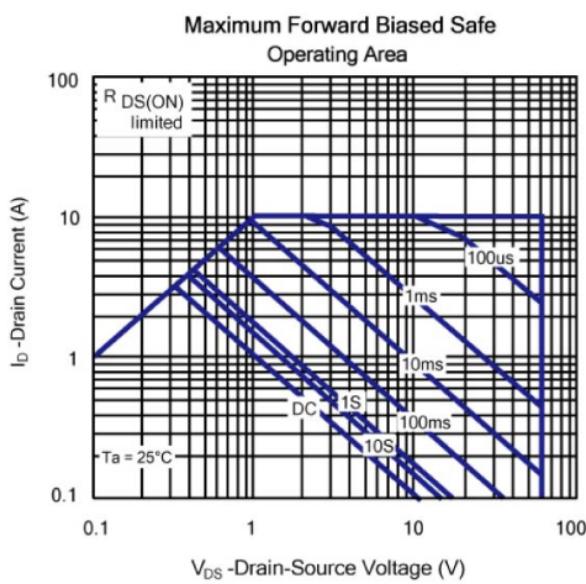
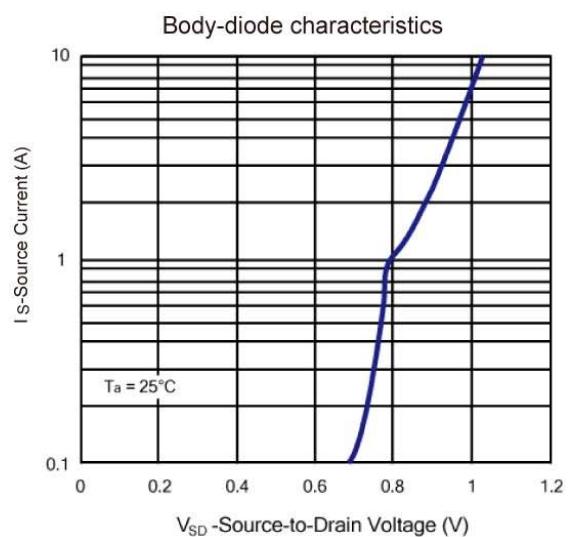
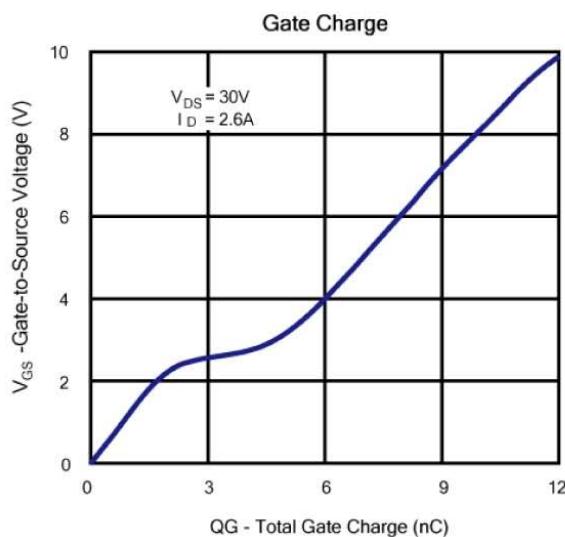
\*The device mounted on 1in<sup>2</sup> FR4 board with 2 oz copper

**LN2308LT1G , S-LN2308LT1G**
**Electrical Characteristics (T<sub>a</sub>=25°C Unless Otherwise Specified)**

<b>Symbol</b>	<b>Parameter</b>	<b>Limit</b>	<b>Min</b>	<b>Typ</b>	<b>Max</b>	<b>Unit</b>
<b>STATIC</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0, I <sub>D</sub> =250 $\mu$ A	60			V
V <sub>GSS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 $\mu$ A	1		3	V
I <sub>GSS</sub>	Gate Body Leakage	V <sub>DS</sub> =0V, V <sub>GS</sub> =±20V			±100	nA
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =60V, V <sub>GS</sub> =0V			1	$\mu$ A
R <sub>DSS(ON)</sub>	Drain-Source On-Resistance	V <sub>GS</sub> =10V, I <sub>D</sub> = 2.6A		82	100	mΩ
		V <sub>GS</sub> =4.5V, I <sub>D</sub> = 2.1A		96	130	
		V <sub>GS</sub> =3.3V, I <sub>D</sub> = 1.8A		139	200	
V <sub>SD</sub>	Diode Forward Voltage	I <sub>S</sub> =1.0A, V <sub>GS</sub> =0V		0.8	1.2	V
<b>DYNAMIC</b>						
Q <sub>G</sub>	Total Gate Charge	V <sub>DS</sub> =30V, V <sub>GS</sub> =10V, I <sub>D</sub> =2.6A		12		nC
Q <sub>G</sub>	Total Gate Charge	V <sub>DS</sub> =30V, V <sub>GS</sub> =4.5V, I <sub>D</sub> =2.6A		6.5		
Q <sub>GS</sub>	Gate-Source Charge			2.2		
Q <sub>GD</sub>	Gate-Drain Charge			2.7		
C <sub>ISS</sub>	Input capacitance	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz		350		pF
C <sub>OSS</sub>	Output Capacitance			40		
C <sub>RSS</sub>	Reverse Transfer Capacitance			12		
R <sub>G</sub>	Gate Resistance	V <sub>DS</sub> =0V, V <sub>GS</sub> =0V, f=1MHz		0.7		$\Omega$
t <sub>d(on)</sub>	Turn-On Delay Time	V <sub>DD</sub> =20V, R <sub>L</sub> =20 $\Omega$ I <sub>D</sub> =1A, V <sub>GEN</sub> =10V R <sub>G</sub> =1 $\Omega$		10		ns
t <sub>r</sub>	Turn-On Rise Time			11		
t <sub>d(off)</sub>	Turn-Off Delay Time			29		
t <sub>f</sub>	Turn-Off Fall Time			3		

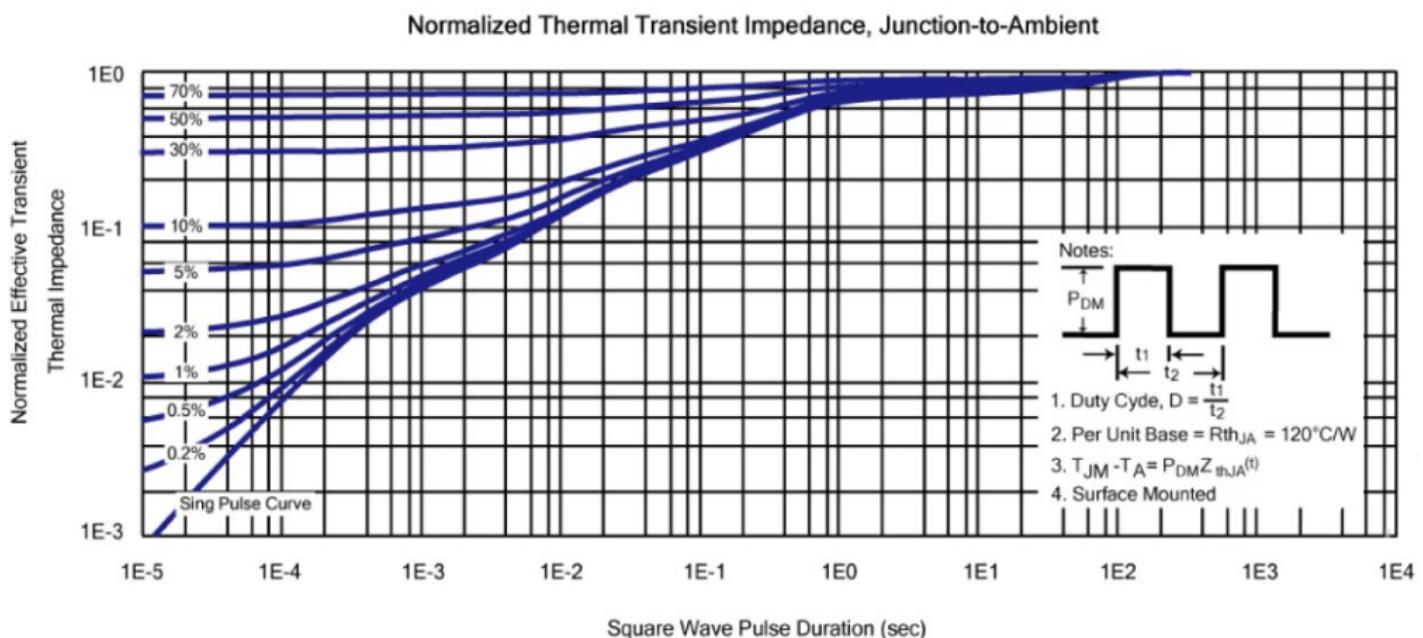
Notes: Pulse test; pulse width  $\leq$  300us, duty cycle  $\leq$  2%.

**Typical Characteristics (Ta =25°C Noted)**

**LN2308LT1G , S-LN2308LT1G**


**Typical Characteristics ( $T_a = 25^\circ\text{C}$  Noted)**
**LN2308LT1G , S-LN2308LT1G**


Typical Characteristics ( $T_a = 25^\circ\text{C}$  Noted)

LN2308LT1G , S-LN2308LT1G

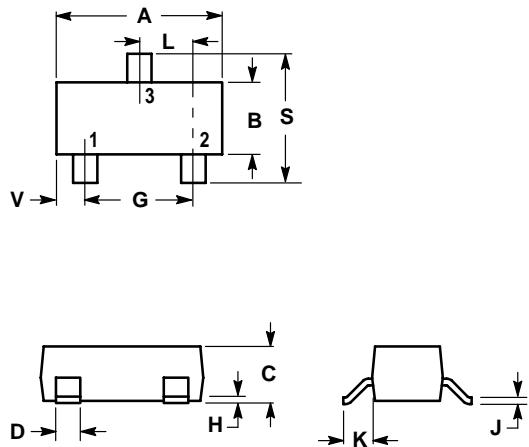


LN2308LT1G , S-LN2308LT1G

### SOT-23

#### NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M,1982
2. CONTROLLING DIMENSION: INCH.



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	0.1102	0.1197	2.80	3.04
B	0.0472	0.0551	1.20	1.40
C	0.0350	0.0440	0.89	1.11
D	0.0150	0.0200	0.37	0.50
G	0.0701	0.0807	1.78	2.04
H	0.0005	0.0040	0.013	0.100
J	0.0034	0.0070	0.085	0.177
K	0.0140	0.0285	0.35	0.69
L	0.0350	0.0401	0.89	1.02
S	0.0830	0.1039	2.10	2.64
V	0.0177	0.0236	0.45	0.60

